

TRANSMITTAL LETTER FOR THE THIRD SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

Enclosed is a Third Supplemental Information Disclosure Statement, including copies of the listed references, for filing in the above-identified patent application.

The Third Supplemental Information Disclosure Statement is being filed after the period specified in 37 CFR 1.97(b), but before the mailing date of any of the following:

- (1) a Final Action under §1.113,
- (2) a Notice of Allowance under §1.311, or
- (3) an Action that otherwise closes prosecution in the application.

Also enclosed is our check in the amount of \$180.00 to cover the fee set forth in 37 CFR 1.17(p).

04/10/2003 MBIZUNES 00000035 09829133 01 FC:1806 180.00 OP Serial No. 09/829,133 - - - 2



Favorable action on the merits of the application is earnestly solicited.

Respectfully submitted,

WOOD, PHILLIPS, KATZ, CLARK & MORTIMER

Paul M. Odell, Reg. No. 28,332

500 West Madison Street, Suite 3800 Chicago, Illinois 60661-2511 (312) 876-1800

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with sufficient postage as First Class Mail in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231, on March 27, 2003.

Paul M. Odell